



WINSTAR Display Co.,Ltd.
華凌光電股份有限公司



Winstar Display Co., LTD
華凌光電股份有限公司

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SPECIFICATION

CUSTOMER : _____

MODULE NO.: **WF28GTLAJDNT0#**

APPROVED BY: (FOR CUSTOMER USE ONLY)	 PCB VERSION: DATA:
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SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
			葉虹蘭
ISSUED DATE: 2020/05/06			

TFT Display Inspection Specification: <https://www.winstar.com.tw/technology/download.html>

Precaution in use of TFT module: <https://www.winstar.com.tw/technology/download/declaration.html>

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2018/08/23		First issue
A	2019/04/23		Modify Touch Panel Information
B	2019/12/16		Modify VDD
C	2020/03/13		Modify VDD
D	2020/05/06		Modify Backlight

Contents

1.Module Classification Information

2.Summary

3.General Specification

4.Absolute Maximum Ratings

5.Electrical Characteristics

6.AC Characteristics

7.Optical Characteristics

8.Interface

9.Block Diagram

10.Reliability

11.Touch Panel Information

12.Contour Drawing

13.Other

1.Module Classification Information

W F 28 G T L A J D N T 0 #
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬

①	Brand : WINSTAR DISPLAY CORPORATION											
②	Display Type : F→TFT Type, J→Custom TFT											
③	Display Size : 2.8” TFT											
④	Model serials no.											
⑤	Backlight Type :		F→CCFL, White S→LED, High Light White						T→LED, White Z→Nichia LED, White			
⑥	LCD Polarize Type/ Temperature range/ Gray Scale Inversion Direction		A→Transmissive, N.T, IPS TFT C→Transmissive, N. T, 6:00 ; F→Transmissive, N.T,12:00 ; I→Transmissive, W. T, 6:00 K→Transflective, W.T,12:00 L→Transmissive, W.T,12:00 N→Transmissive, Super W.T, 6:00						Q→Transmissive, Super W.T, 12:00 R→Transmissive, Super W.T, O-TFT V→Transmissive, Super W.T, VA TFT W→Transmissive, Super W.T, IPS TFT X→Transmissive, W.T, VA TFT Y→Transmissive, W.T, IPS TFT Z→Transmissive, W.T, O-TFT			
⑦	A : TFT LCD B : TFT+SCREW HOLES+CONTROL BOARD C : TFT+ SCREW HOLES +A/D BOARD D : TFT+ SCREW HOLES +A/D BOARD+CONTROL BOARD E : TFT+ SCREW HOLES +POWER BOARD						F : TFT+CONTROL BOARD G : TFT+ SCREW HOLES H : TFT+D/V BOARD I : TFT+ SCREW HOLES +D/V BOARD J : TFT+POWER BD					
⑧	Resolution:											
	A	128160	B	320234	C	320240	D	480234	E	480272	F	640480
	G	800480	H	1024600	I	320480	J	240320	K	800600	L	240400
	M	1024768	N	128128	P	1280800	Q	480800	R	640320	S	480128
	T	800320	U	8001280	V	176220	W	1280398	X	1024250	Y	1920720
	Z	800200	2	1024324	3	7201280	4	19201200	5	1366768	6	1280320
⑨	D: Digital L : LVDS M:MIPI											
⑩	Interface:											
	N	Without control board			A	8Bit		B	16Bit		H	HDMI
	I	I2C Interface			R	RS232		S	SPI Interface		U	USB
⑪	TS:											
	N	Without TS			T	Resistive touch panel			C	Capacitive touch panel (G-F-F)		
	G	Capacitive touch panel (G-G)					C1	Capacitive touch panel (G-F-F)+OCA				
	C2	Capacitive touch panel (G-F-F)+OCR					G1	Capacitive touch panel (G-G)+OCA				
	G2	Capacitive touch panel (G-G)+OCR					B	CTP+GG+USB				
⑫	Version: X:Raspberry pi											
⑬	Special Code		#:Fit in with ROHS directive regulations									

2.Summary

TFT 2.8" is a TN transmissive type color active matrix TFT liquid crystal display that uses amorphous silicon TFT as switching devices. This module is composed of a TFT_LCD module. It is usually designed for industrial application and this module follows RoHS.

3.General Specifications

Item	Dimension	Unit
Size	2.8"	
Dot Matrix	240 x RGB x 320(TFT)	dots
Module dimension	50.0(W) x 69.2(H) x 3.48(D)	mm
Active area	43.2 x 57.6	mm
Dot pitch	0.18 x 0.18	mm
LCD type	TFT, Normally White, Transmissive	
TFT Interface	SPI	
TFT Driver IC	Himax8347-I or Equivalent	
View Direction	6 o'clock	
Gray Scale Inversion Direction	12 o'clock	
Interface	SPI	
Aspect Ratio	Portrait	
Backlight Type	LED, Normally White	
With /Without TP	With RTP	
Surface	Glare	

*Color tone slight changed by temperature and driving voltage.

4.Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-20	—	+70	°C
Storage Temperature	TST	-30	—	+80	°C

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 40^{\circ}\text{C}$, 90% RH MAX. Temp. $> 40^{\circ}\text{C}$, Absolute humidity shall be less than 90% RH at 40°C

5. Electrical Characteristics

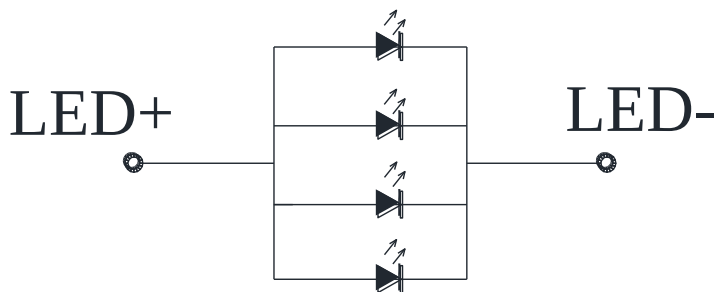
5.1. Operating conditions

Item	Symbol	Min	Typ	Max	Unit
Supply Voltage For Analog	V_{DD}	2.5	—	3.0	V
Supply Current For LCM	I_{DD}	—	5	7.5	mA

5.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	—	—	80	—	mA	—
Power Consumption	—	224	256	272	mW	—
LED voltage	LED+	2.8	3.2	3.4	V	Note 1
LED Life Time	—	50,000	—	—	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



Back Light Circuit

Note 2 : $T_a = 25\text{ }^{\circ}\text{C}$

Note 3 : Brightness to be decreased to 50% of the initial value

Note 4 : The single LED lamp case

6.AC Characteristics

6.1. 4-wire Serial interface characteristics

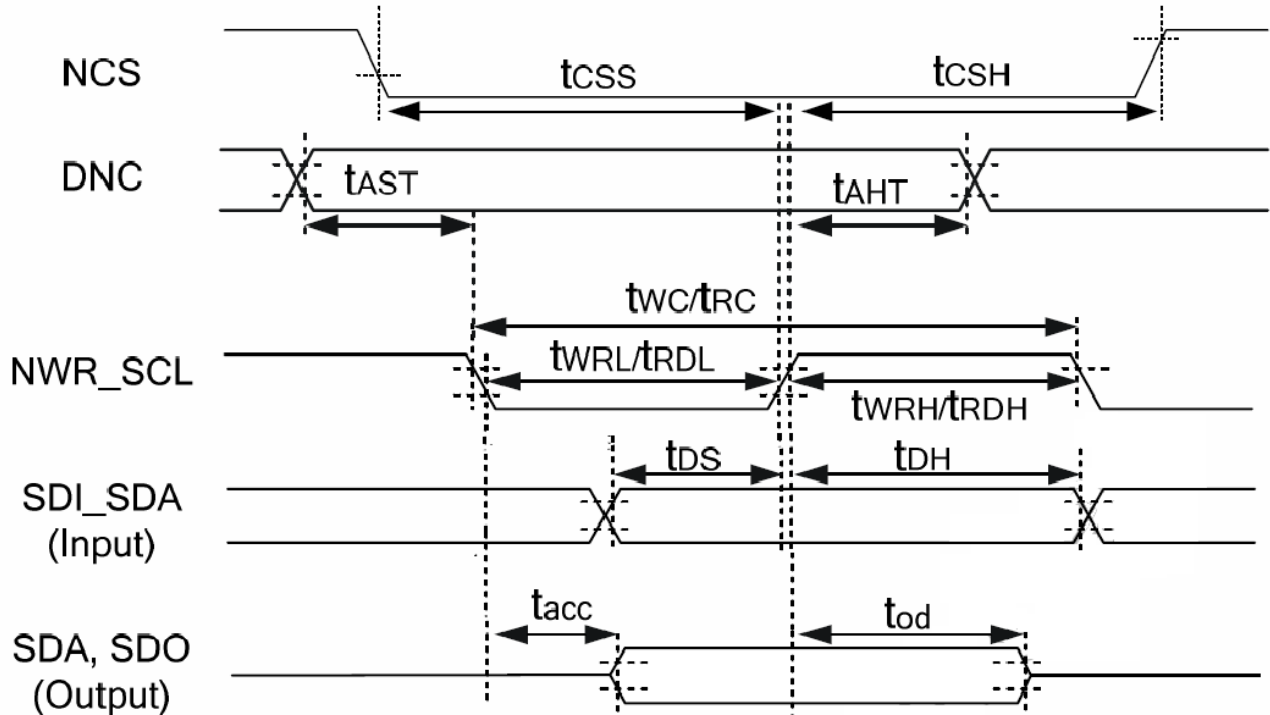


Figure 1 4-wire Serial interface characteristics

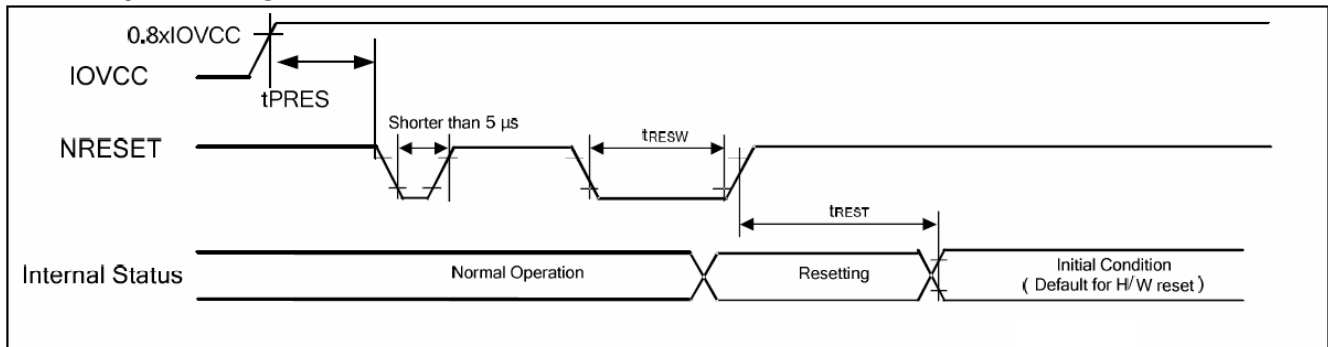
6.2. (VSSA=0V, IOVCC=1.65V to 3.3V, VCI=2.5V to 3.3V, TA=-30 to 70°C)

Signal	Symbol	Parameter	Min.	Max.	Unit	Description
NCS	t_{CSS} t_{CSH}	Chip select setup time (Read) Chip select hold time (Read)	60 65	- -	ns	-
DNC	t_{AST} t_{AHT}	Address setup time Address hold time (Write/Read)	0 10	- -	ns	-
NWR_SCL (Write)	t_{WC} t_{WRH} t_{WRL}	Write cycle Control pulse "H" duration Control pulse "L" duration	14 6 6	- - -	ns	-
NWR_SCL (Read)	t_{RC} t_{RDH} t_{RDL}	Read cycle Control pulse "H" duration Control pulse "L" duration	150 60 60	- - -	ns	-
SDI_SDA (Input)	t_{DS} t_{DT}	Data setup time Data hold time	6 6	- -	ns	For maximum CL=30pF For minimum CL=8pF
SDA, SDO (Output)	t_{RACC} t_{OD}	Read access time Output disable time	10 15	50 50	ns	

Note: The input signal rise time and fall time (t_r , t_f) is specified at 15 ns or less.

Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

Reset input timing



Symbol	Parameter	Related Pins	Spec.			Note	Unit
			Min.	Typ.	Max.		
tRESW	Reset low pulse width ⁽¹⁾	NRESET	10	-	-		us
tREST	Reset complete time ⁽²⁾	-	-	-	5	When reset applied during STB OUT mode	ms
		-	-	-	120	When reset applied during STB mode	ms
tPRES	Reset goes high level after Power on time	NRESET & IOVCC	1	-	-	Reset goes high level after Power on	ms

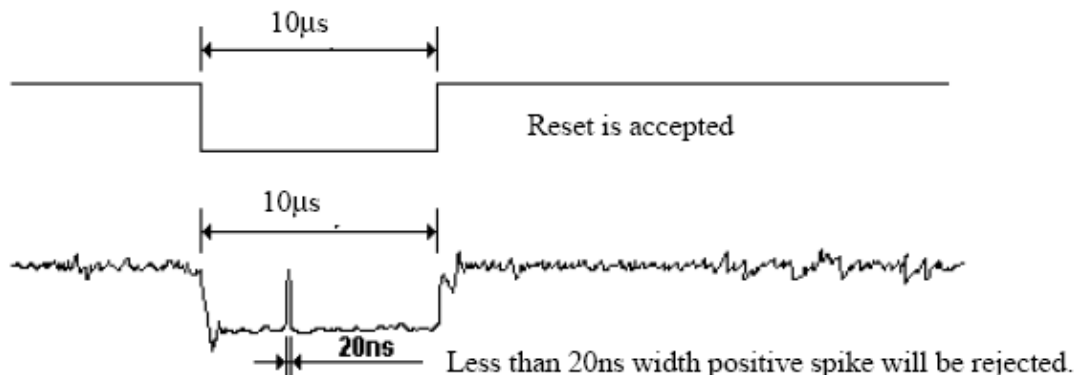
Note: (1) Spike due to an electrostatic discharge on NRESET line does not cause irregular system reset according to the table below.

NRESET Pulse	Action
Shorter than 5 μs	Reset Rejected
Longer than 10 μs	Reset
Between 5 μs and 10 μs	Reset Start

(2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in STB Out –mode. The display remains the blank state in STB –mode) and then return to Default condition for H/W reset.

(3) During Reset Complete Time, VMF value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of NRESET.

(4) Spike Rejection also applies during a valid reset pulse as shown below:



(5) It is necessary to wait 5msec after releasing !RES before sending commands. Also STB Out

7.Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	4	-	ms	Note 3
		Tf		-	12	-	ms	
Contrast ratio		CR	At optimized viewing angle	-	500	-	-	Note 4
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.26	0.31	0.36		Note 2,6,7
		Wy		0.28	0.33	0.38		
Viewing angle (Gray Scale Inversion Direction)	Hor.	ΘR	$CR \geq 10$	-	45	-	Deg.	Note 1
		ΘL		-	45	-		
	Ver.	ΦT		-	50	-		
		ΦB		-	20	-		
Brightness		-	-	250	350	-	cd/m ²	Center of display
Uniformity		(U)	-	70	-	-	%	Note5

Ta=25±2℃

Note 1: Definition of viewing angle range

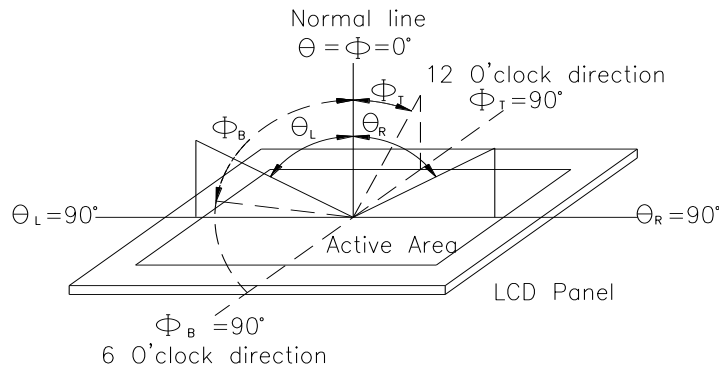


Fig. 7.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7 or BM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

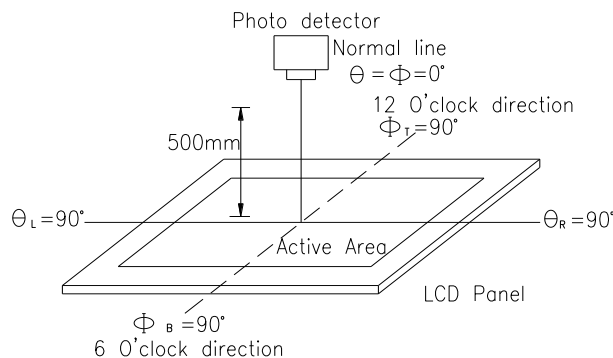
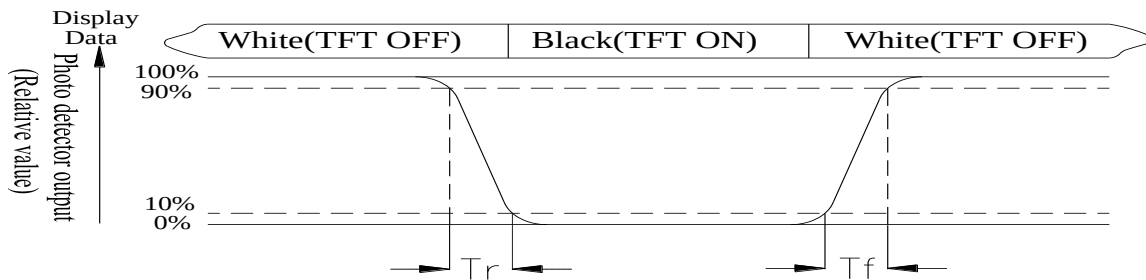


Fig. 7.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = $L_{\min}/L_{\max} \times 100\%$

L = Active area length

W = Active area width

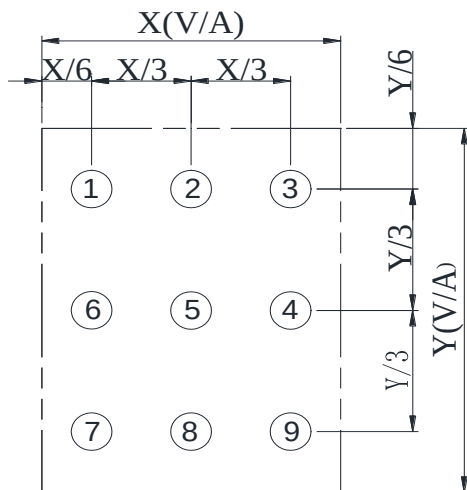


Fig7.3. Definition of uniformity

Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

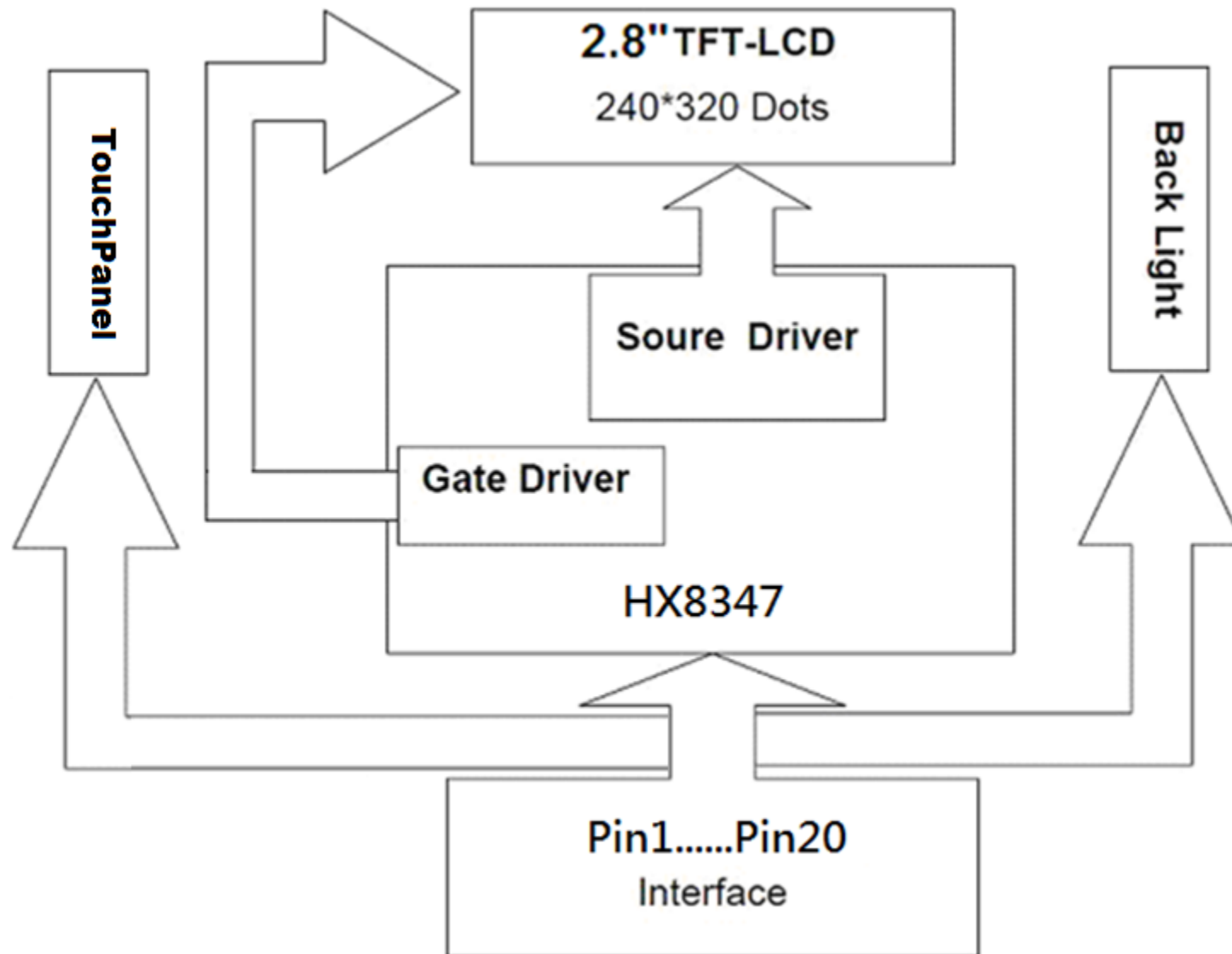
Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

8.Interface

8.1. LCM PIN Definition

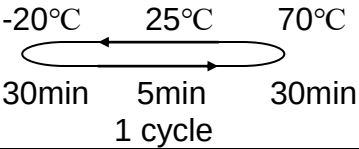
NO	Symbol	Function
1	GND	Ground
2	LED+	Anode of LED backlight.
3	LED-	Cathode of LED backlight.
4	GND	Ground
5	VDD	Power supply(TYP:2.8V).
6	RESET	System reset pin.
7	SDA	Serial data input pin and output pin(SDA) in serial bus system interface I. Serial data input pin (SDI) in serial bus system interface II. The data is inputted on the rising edge of the SCL signal. If not used, please let it open or connected to VSSD.
8	SCL	(NWR) Write enable pin I80 parallel bus system interface. (SCL) server as serial data clock in serial bus system interface when IFSEL=0. Fix it to IOVCC or VSSD level when not used.
9	CS	Chip select signal. Low: chip can be accessed; High: chip cannot be accessed. Must be connected to VSSD if not in use.
10	RS	Command / parameter or display data selection pin
11	GND	Ground
12	SDO	Serial data output pin (SDO) in serial bus system interface II. If not used, please open this pin.
13	TE	Tearing effect output. If not used, please open this pin
14	IM3	serial interface I / serial interface II
15	GND	Ground
16	XR	Right electrode
17	YD	Bottom electrode
18	XL	Left electrode
19	YU	Top electrode
20	GND	Ground

9. Block Diagram



10. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

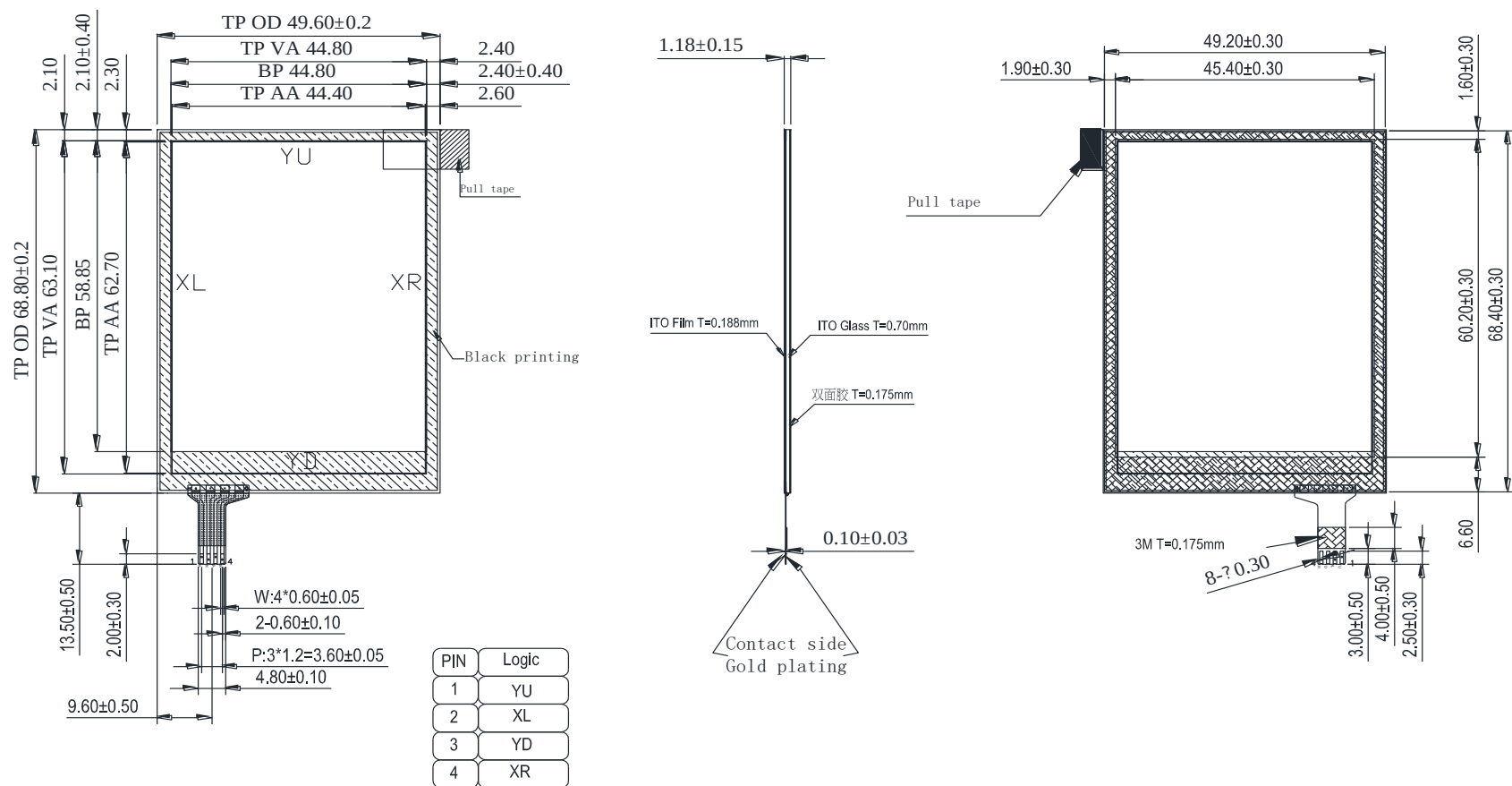
Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 96hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 96hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 96hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 96hrs	1
High Temperature/Humidity Operation	The module should be allowed to stand at 40°C,90%RH max	40°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-20°C/70°C 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ,±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

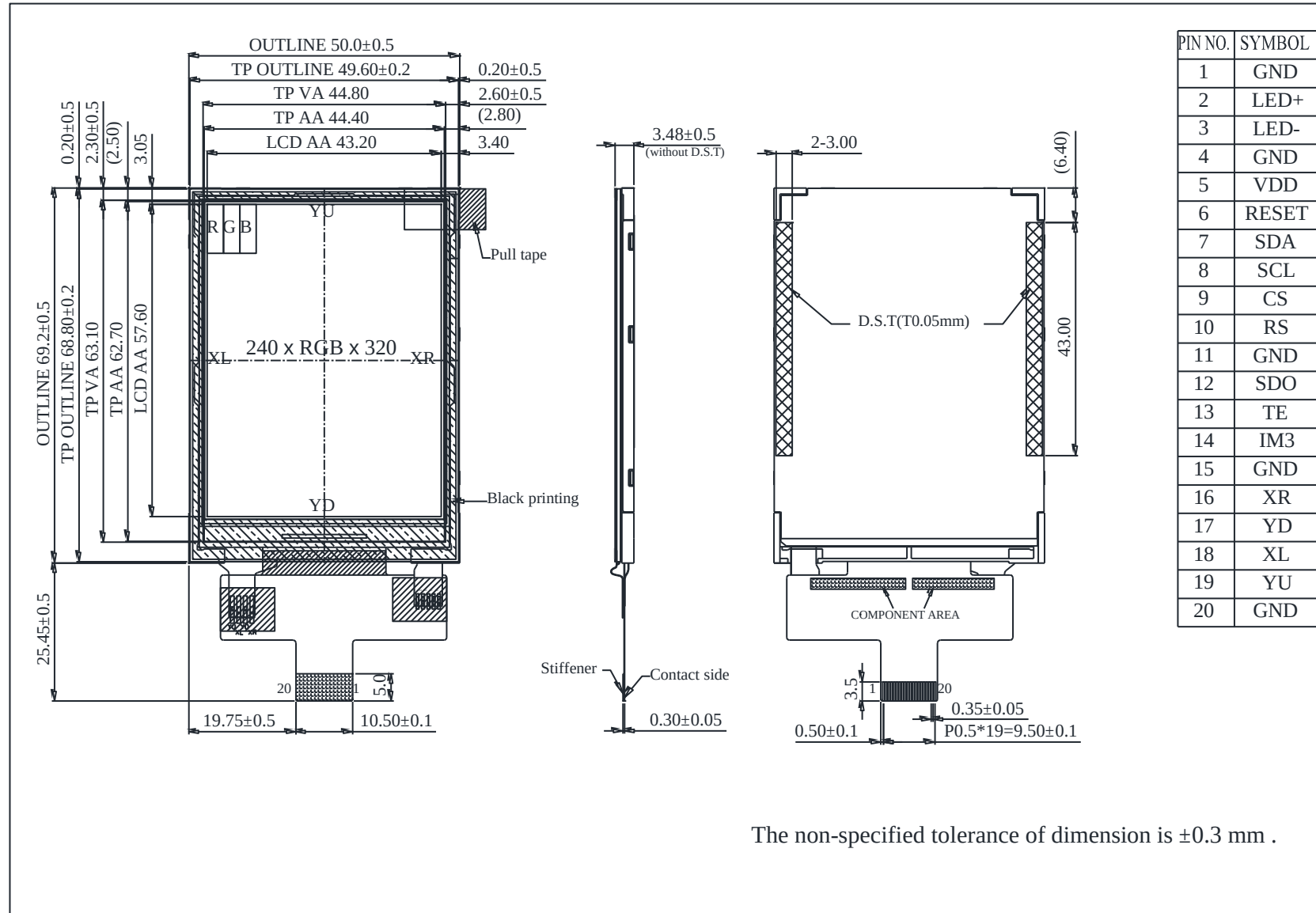
11.Touch Panel Information



11.1. Resistance Touch Panel General Specifications

Item	Description
Driving condition	DC5V
Operating force	20~100g
Linearity max	$\leq 1.5\%$
Insulating resistance	$> 20\text{M}\Omega$, 25V(DC)
Light transparence	70%
Structure type	ITO Film/ITO Glass(F/G)
Surface Hardness	3H typ
Pen Hitting Durability (with the silicon rubber)	$> 1000,000$ times
X resistance	150~500 Ω
Y resistance	350~900 Ω

12. Contour Drawing



**1、Panel Specification :**

- | | | |
|----------------------------|-------------------------------|-------------------------------------|
| 1. Panel Type : | ☐ Pass | ☐ NG , _____ |
| 2. View Direction : | ☐ Pass | ☐ NG , _____ |
| 3. Numbers of Dots : | ☐ Pass | ☐ NG , _____ |
| 4. View Area : | ☐ Pass | ☐ NG , _____ |
| 5. Active Area : | ☐ Pass | ☐ NG , _____ |
| 6. Operating Temperature : | ☐ Pass | ☐ NG , _____ |
| 7. Storage Temperature : | ☐ Pass | ☐ NG , _____ |
| 8. Others : | _____ | |

2、Mechanical Specification :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. PCB Size : | ☐ Pass | ☐ NG , _____ |
| 2. Frame Size : | ☐ Pass | ☐ NG , _____ |
| 3. Material of Frame : | ☐ Pass | ☐ NG , _____ |
| 4. Connector Position : | ☐ Pass | ☐ NG , _____ |
| 5. Fix Hole Position : | ☐ Pass | ☐ NG , _____ |
| 6. Backlight Position : | ☐ Pass | ☐ NG , _____ |
| 7. Thickness of PCB : | ☐ Pass | ☐ NG , _____ |
| 8. Height of Frame to PCB : | ☐ Pass | ☐ NG , _____ |
| 9. Height of Module : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

3、Relative Hole Size :

- | | | |
|-----------------------------|-------------------------------|-------------------------------------|
| 1. Pitch of Connector : | ☐ Pass | ☐ NG , _____ |
| 2. Hole size of Connector : | ☐ Pass | ☐ NG , _____ |
| 3. Mounting Hole size : | ☐ Pass | ☐ NG , _____ |
| 4. Mounting Hole Type : | ☐ Pass | ☐ NG , _____ |
| 5. Others : | ☐ Pass | ☐ NG , _____ |

4、Backlight Specification :

- | | | |
|---|-------------------------------|-------------------------------------|
| 1. B/L Type : | ☐ Pass | ☐ NG , _____ |
| 2. B/L Color : | ☐ Pass | ☐ NG , _____ |
| 3. B/L Driving Voltage (Reference for LED Type) : | ☐ Pass | ☐ NG , _____ |
| 4. B/L Driving Current : | ☐ Pass | ☐ NG , _____ |
| 5. Brightness of B/L : | ☐ Pass | ☐ NG , _____ |
| 6. B/L Solder Method : | ☐ Pass | ☐ NG , _____ |
| 7. Others : | ☐ Pass | ☐ NG , _____ |

>> **Go to page 2** <<



Winstar Module Number : _____

Page: 2

5、Electronic Characteristics of Module :

- | | | |
|------------------------------|-------------------------------|-------------------------------------|
| 1. Input Voltage : | ☐ Pass | ☐ NG , _____ |
| 2. Supply Current : | ☐ Pass | ☐ NG , _____ |
| 3. Driving Voltage for LCD : | ☐ Pass | ☐ NG , _____ |
| 4. Contrast for LCD : | ☐ Pass | ☐ NG , _____ |
| 5. B/L Driving Method : | ☐ Pass | ☐ NG , _____ |
| 6. Negative Voltage Output : | ☐ Pass | ☐ NG , _____ |
| 7. Interface Function : | ☐ Pass | ☐ NG , _____ |
| 8. LCD Uniformity : | ☐ Pass | ☐ NG , _____ |
| 9. ESD test : | ☐ Pass | ☐ NG , _____ |
| 10. Others : | ☐ Pass | ☐ NG , _____ |

6、Summary :

Sales signature : _____

Customer Signature : _____

Date : / / _____